# Rocktech Displays Limited



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Version: 1.0

Description: 1.77 inch TFT 128\*160 Pixels with

LED backlight,240 nits brightness

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## **Revision History**

Date	Rev.	Page	Description
2017-12-20	1.0	All	First issue



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## 1. General Features

Item	Spec	Remark
Display Mode	Normally White transmissive	
Viewing Direction	12 O'CLOCK	
Input Signals	MCU	
Outside Dimensions	33.30 (W) x42.94(H) x2.20(D)	
Active Area	28.03mm(W)×35.04mm(H)	
Number of Pixels	128(RGB)×160	
Dot Pitch	0.219mm(W) × 0.219mm(H)	
Pixel Arrangement	RGB Vertical stripes	
Drive IC	ST7735S	



# 2. Absolute Maximum Ratings

The following are maximum values which, if exceeded may cause operation or damage to the unit.

ITEM	Sym.	Min.	Тур.	Max.	Unit	Remark
Power for Circuit Driving	VDD	-0.3	-	4.8	V	
Power for Circuit Logic	Vt	-0.3	-	VDD+0.3	V	
Storage Humidity	H <sub>ST</sub>	10	-		%RH	
Storage Temperature	T <sub>ST</sub>	-30	-	80	$^{\circ}\!\mathbb{C}$	At
Operating Ambient Humidity	H <sub>OP</sub>	10	-		%RH	<b>25±5</b> ℃
Operating Ambient temperature	T <sub>OP</sub>	-20	-	70	$^{\circ}$	



## 3. Electrical Specification

### 3.1 Driving TFT LCD Panel

Item		Sym.	Min	Тур.	Max	Unit	Note
Power for (	Circuit Driving	VDD	2.6	3.3	3.6	V	
Power for Logic Circuit		VDDIO	1.65	1.8	3.3	V	
Logic Input	Low Voltage	VIL	GND	1	0.3VDD	V	
Voltage High Volta		ViH	0.7VDD	1	VDD	V	
Logic Output Low Voltage		Vol	GND	1	0.2VDD	V	
Voltage	High Voltage	Vон	0.8VDD	-	VDD	V	

### 3.2 Driving Backlight

Item	Sym.	Min	Тур.	Max	Unit	Note
Backlight driving voltage	VF	-	3.2	-	V	
Backlight driving current	lF	30	40	50	mA	
Backlight Power Consumption	WBL	-	128	-	mW	
Life Time	-	-	50,000	-		Note 3

Note 1: (Unless specified, the ambient temperature Ta=25℃)

Note 2: The recommended operating conditions refer to a range in which operation of this product is guaranteed. Should this range is exceeded, the operation cannot be guaranteed even if the values may be without the absolute maximum ratings.

Note 3: If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.



### **4.Optical Specifications**

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 30 minutes in a dark environment at 25  $^{\circ}$ C. The values specified are at an approximate distance 500mm from the LCD surface at a viewing angle of  $\Phi$  and  $\theta$  equal to  $0^{\circ}$ .

Hom	Curre		Values		11-2:4	Nata	
Item	Sym.	Min.	Тур.	Max.	Unit	Note	
1)Contrast Ratio	C/R	200	300	-		FIG.1	
2)Module Luminance	L	190	240	-	cd/m <sup>2</sup>	FIG.1	
3)Response time	Tr+Tf	-	30	60	ms	FIG.2	
	θτ	50	60	-			
A)\/iavainan Anada	θв	40	50	-	D	FIO 2	
4)Viewing Angle	θL	50	60	-	Degree	FIG.3	
	$\theta_{R}$	50	60	-			
	Wx	0.278	0.318	0.358			
	Wy	0.297	0.337	0.377			
	Rx	-	-	-			
	Ry		-	-			
5)Chromaticity	Gx	-	-	-			
	Gy	-	-	-			
	Вх	-	-	-			
	Ву	-	-	-			



### ♦ Measurement System

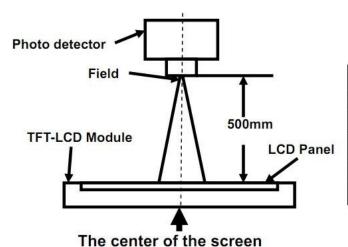
#### Notes:

1. Contrast Ratio(CR) is defined mathematically as:

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- 2. Surface luminance is the center point across the LCD surface 500mm from the surface with all pixels displaying white. For more information see FIG 1.
- 3. Response time is the time required for the display to transition from white to black (Rising Time, Tr) and from black to white (Falling Time, Tf). For additional information see FIG 2.
- 4. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

#### FIG. 1 Optical Characteristic Measurement Equipment and Method



Item	Photo detector	Field
Contrast Ratio		
Luminance	00.04	40
Chromaticity	SR-3A	1°
Lum Uniformity		
Response Time	BM-7A	2°

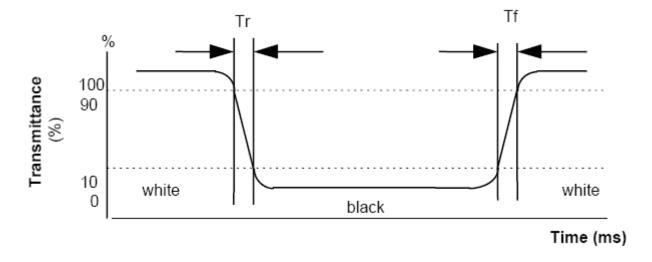


### FIG. 2 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

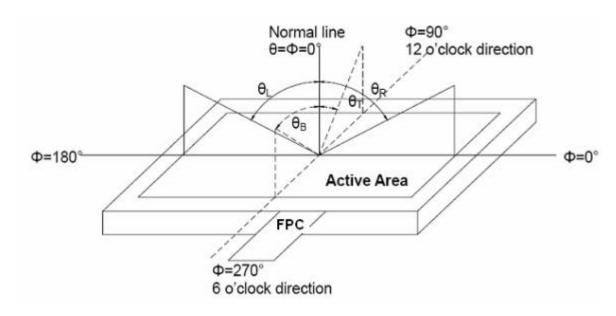
Response Time = Rising Time(Tr) + Falling Time(Tf)

- Rising Time(Tr): Full White 90% → Full White 10% Transmittance.
- Falling Time(Tf): Full White 10% → Full White 90% Transmittance.



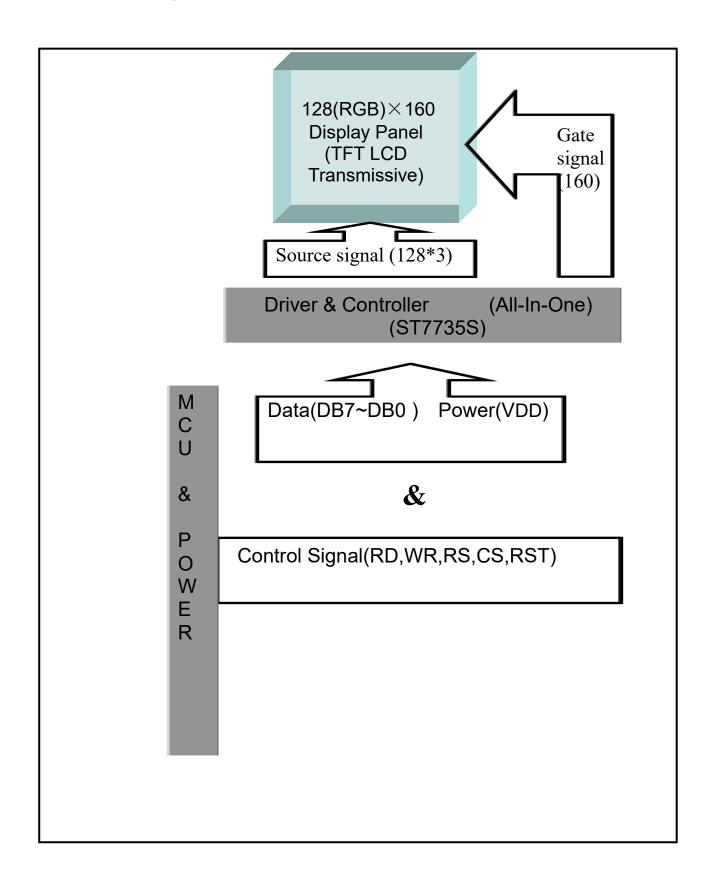
### FIG. 3 The definition of Viewing Angle

Use Fig. 1(Test Procedure) under Measurement System to measure the contrast from the measuring direction specified by the conditions as the following figure.





## 5.Block Diagram





# 6.Pin Description

Item	Terminal	Functions
1	BL-K	LED cathode
2	BL-A	LED anode
3	GND	Ground
4	VDD	Power input 2.8-3.3V
5	VDDIO	Power input 1.8-3.3V
6	IM2	IM2=1,Parallel Interface; IM2=0,Serial Interface
7	CS	Chip select pin
8	RST	Reset pin
9	RS	Data select pin
10	WR	Write pin
11	RD	Read pin
12-19	DB7-DB0	DATA BUS
20	GND	Ground

## 7.Timing Characteristics(details refer to ST7735S)



## **Parallel Interface Characteristics**

(1).18,16,9 or 8-bit Bus(8080 Series MCU Interface)

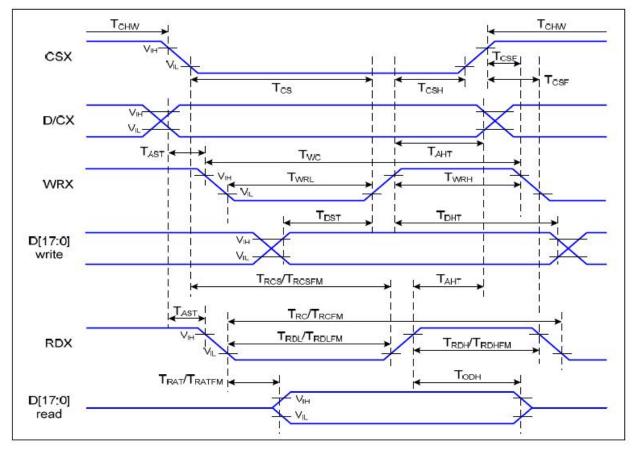


Figure 1 Parallel Interface Timing Characteristics (8080 Ceries MCU Interface)

Ta=25 °C, VDDI=1.65~3.7V, VDD=2.5~4.8V

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	TAST	Address Setup Ttime	0		ns	
DICX	TAHT	Address Hold Time (Write/Read)	10		ns	- N -
	TCHW	Chip Select "H" Pulse Width	0		ns	
	TCS	Chip Select Setup Time (Write)	15		ns	
CCV	TRCS	Chip Select Setup Time (Read ID)	45		ns	
CSX	TRCSFM	Chip Select Setup time (Read FM)	355		ns	Ī -
	TCSF	Chip Select Wait Time (Write/Read)	10		ns	
	TCSH	Chip Select Hold Time	10		ns	
	TWC	Write Cycle	66		ns	
WRX	TWRH	Control Pulse "H" Duration	15		ns	
	TWRL	Control Pulse "L" Duration	15		ns	
	TRC	Read Cycle (ID)	160		ns	
RDX (ID)	TRDH	Control Pulse "H" Duration (ID)	90		ns	When Read ID Data
	TRDL	Control Pulse "L" Duration (ID)	45		ns	



RDX TRCFM	Read Cycle (FM)	450		ns	When Read from	
	TRDHFM	Control Pulse "H" Duration (FM)	90		ns	Frame Memory
(FM) TRDLFM	TRDLFM	Control Pulse "L" Duration (FM)	355		ns	- Frame Memory
	TDST	Data Setup Time	10		ns	
	TDHT	Data Hold Time	10		ns	
D[17:0]	TRAT	Read Access Time (ID)		40	ns	For CL=30pF
	TRATFM	Read Access Time (FM)		340	ns	
	TODH	Output Disable Time	20	80	ns	

Table 4 8080 Parallel Interface Characteristics

#### (2).18,16,9 or 8-bit Bus(6800 Series MCU Interface)

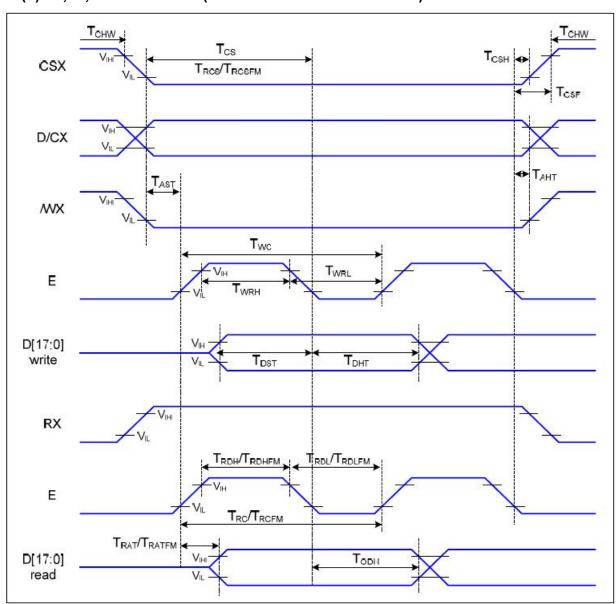


Figure 5 Parallel Interface Timing Characteristics (6800-Series MCU Interface)



Ta=25 °C, VDDI=1.65~3.7V, VDD=2.5~4.8V

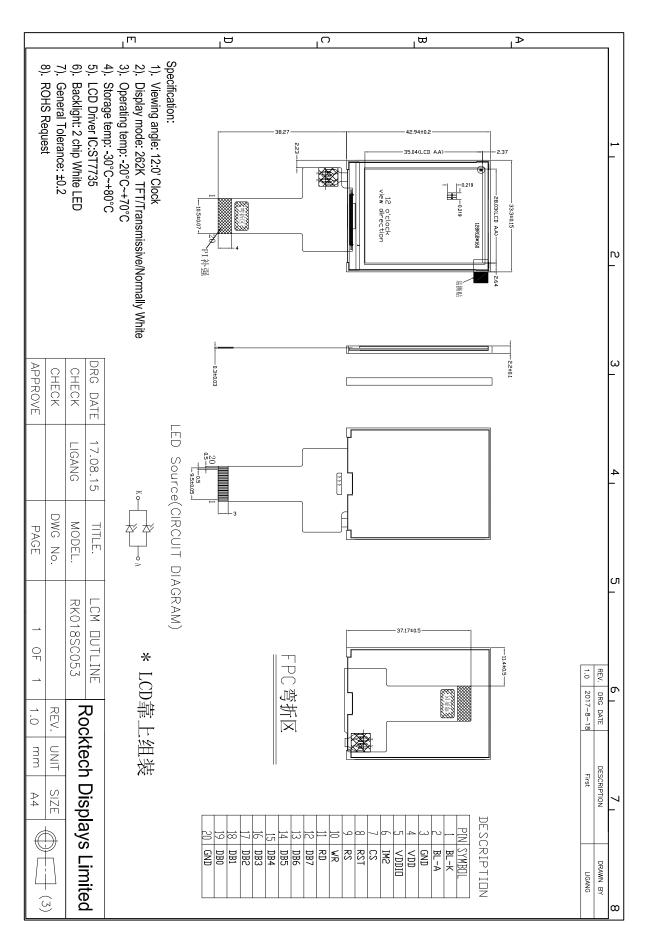
Signal	Symbol	Parameter	Min	Max	Unit	Description	
D/CX	T <sub>AST</sub>	Address Setup Time	0		ns		
DICX	T <sub>AHT</sub>	Address Hold Time (Write/Read)	10		ns	-	
	T <sub>CHW</sub>	Chip Select "H" Pulse Width	0		ns		
	T <sub>CS</sub>	Chip Select Setup Time (Write)	15		ns		
CSX	T <sub>RCS</sub>	Chip Select Setup Time (Read ID)	45		ns		
COX	T <sub>RCSFM</sub>	Chip Select Setup Time (Read FM)	355		ns	(-)	
	T <sub>CSF</sub>	Chip Select wait Time (Write/Read)	10		ns		
	T <sub>CSH</sub>	Chip Select Hold Time	10		ns		
	T <sub>WC</sub>	Write Cycle	66		ns		
WRX	T <sub>WRH</sub>	Control Pulse "H" Duration	15		ns		
	T <sub>WRL</sub>	Control Pulse "L" Duration	15		ns		
	T <sub>RC</sub>	Read Cycle (ID)	160		ns		
RDX (ID)	T <sub>RDH</sub>	Control Pulse "H" Duration (ID)	90		ns	When Read ID Data	
	T <sub>RDL</sub>	Control Pulse "L" Duration (ID)	45		ns		
	T <sub>RCFM</sub>	Read Cycle (FM)	450		ns	M/h D d Fu	
RDX (FM)	T <sub>RDHFM</sub>	Control Pulse "H" Duration (FM)	90		ns	When Read From	
	T <sub>RDLFM</sub>	Control Pulse "L" Duration (FM)	355		ns	Frame Memory	
	T <sub>DST</sub>	Data Setup Time	10		ns	For Maximum	
D[17:0]	T <sub>DHT</sub>	Data Hold Time	10		ns	CL=30pF	
	T <sub>ODH</sub>	Output Disable Time	20	80	ns	For Minimum CL=8pF	

Table 5 6800 Parallel Interface Characteristics

Note: The rising time and falling time (Tr, Tf) of input signal are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals



#### **8.Outline Dimension**





## 9. Reliability and Inspection Standard

No.	Test Item		Test Conditions	Remark
1	High Temperature	Storage	80℃, 120Hr	Note
		Operation	<b>70</b> ℃, <b>120</b> Hr	Note
2	Low Temperature	Storage	-30℃, 120Hr	Note
		Operation	-20℃, 120Hr	
3	High Temperature and High Humidity		40℃, 90%RH, 120Hr	Note
4	Thermal Cycling Test(No operation)		-20℃ for 30min, 70℃ for 30 min. 100 cycles. Then test at room temperature after 1 hour	Note
5	Vibration Test(No operation)		Frequency:10~55 HZ; Stroke:1.5 mm;Sweep:10HZ~55HZ~10HZ; 2hours for each direction of X, Y, Z(6 hours for total)	
6	Package Drop Test		Height:60 cm,1 corner, 3 edges, 6 surfaces	
7	Electro Static Discharge		$\pm 2$ KV,Human Body Mode, 100pF/1500 $\Omega$	

#### Note:

- 1) Sample quantity for each test item is 5~10pcs.
- 2) Note 4: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.



### 10.PRECAUTIONS FOR USING LCD MODULES

#### **Handing Precautions**

- (1) The display panel is made of glass and polarizer. As glass is fragile, it tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
  - Isopropyl alcohol
  - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
  - Water
  - Ketone
  - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD module.
- (10) NC terminal should be open. Do not connect anything.
- (11) If the logic circuit power is off, do not apply the input signals.
- (12) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
  - Do not alter, modify or change the shape of the tab on the metal frame.
  - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
  - Do not damage or modify the pattern writing on the printed circuit board.
  - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal



connector

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist LCM.

#### **Storage Precautions**

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

#### **Others**

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature. If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- -Terminal electrode sections.